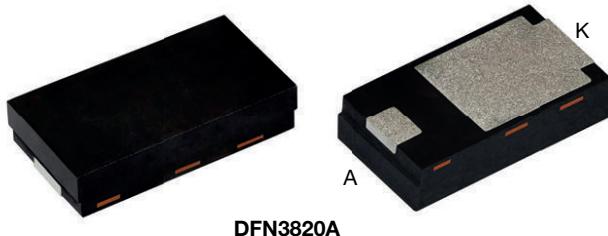


Surface-Mount Standard Rectifier



LINKS TO ADDITIONAL RESOURCES



FEATURES

- Low-profile package- typical height of 0.88 mm
- Leadless DFN package with side-wettable flanks suitable for customer AOI (Automatic Optical Inspection)
- Ideal for automated replacement
- Oxide planar chip junction
- Low forward voltage drop
- Typical IR less than 0.1 μ A
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Compatible to SMP (DO-220AA) package case outline
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 A
V_{RRM}	200 V, 400 V, 600 V
I_{FSM}	32 A
V_F at $I_F = 2$ A ($T_J = 125$ °C)	0.86 V
T_J max.	175 °C
Package	DFN3820A
Circuit configuration	Single

TYPICAL APPLICATIONS

General purpose, power line polarity protection and rail-to-rail protection in consumer, industrial, and automotive applications.

MECHANICAL DATA

Case: DFN3820A

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)					
PARAMETER	SYMBOL	SE20ND	SE20NG	SE20NJ	UNIT
Device marking code		2D	2G	2J	
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	V
Maximum average forward rectified current (fig.1)	$I_{F(AV)}^{(1)}$	2			A
	$I_{F(AV)}^{(2)}$	1.5			
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	32			A
Operating junction temperature range	T_J ⁽³⁾	-55 to +175			°C
Storage temperature range	T_{STG}	-55 to +175			

Notes

(1) Mounted on 10 mm x 10 mm pad areas, 2 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area

(3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	$I_F = 1\text{ A}$	$T_J = 25^\circ\text{C}$	V_F ⁽¹⁾	0.91	-	V	
	$I_F = 2\text{ A}$			0.96	1.10		
	$I_F = 1\text{ A}$	$T_J = 125^\circ\text{C}$		0.79	-		
	$I_F = 2\text{ A}$			0.86	0.98		
Reverse current	Rated V_R	$T_J = 25^\circ\text{C}$	I_R ⁽²⁾	-	5	μA	
		$T_J = 125^\circ\text{C}$		8	100		
Typical reverse recovery time	$I_F = 0.5\text{ A}$, $I_R = 0.1\text{ A}$, $I_{rr} = 0.25\text{ A}$	t_{rr}		1200	-	ns	
Typical junction capacitance	4.0 V, 1 MHz	C_J		12	-	pF	

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width $\leq 5\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise specified)					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Thermal resistance	$R_{\theta JA}$ ⁽¹⁾⁽²⁾	135	169	$^\circ\text{C/W}$	
	$R_{\theta JM}$ ⁽³⁾	5	6.3		

Notes

(1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

(3) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS						
$(T_A = 25^\circ\text{C}$ unless otherwise noted)						
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE	
AEC-Q101-001	Human body model (contact mode)	$C = 100\text{ pF}$, $R = 1.5\text{ k}\Omega$	V_C	H3B	$> 8\text{ kV}$	
AEC-Q101-002	Machine model (contact mode)	$C = 200\text{ pF}$, $R = 0\text{ }\Omega$		M4	$> 400\text{ V}$	
JESD22-A114	Human body model (contact mode)	$C = 100\text{ pF}$, $R = 1.5\text{ k}\Omega$		3B	$> 8\text{ kV}$	
JESD22-A115	Machine model (contact mode)	$C = 200\text{ pF}$, $R = 0\text{ }\Omega$		C	$> 400\text{ V}$	
IEC 61000-4-2 ⁽²⁾	Human body model (contact mode)	$C = 150\text{ pF}$, $R = 330\text{ }\Omega$		4	$> 8\text{ kV}$	
	Human body model (air-discharge mode) ⁽¹⁾	$C = 150\text{ pF}$, $R = 330\text{ }\Omega$		4	$> 15\text{ kV}$	

Notes

(1) Immunity to IEC 61000-4-2 air discharge mode has a typical performance $> 30\text{ kV}$

(2) System ESD standard

ORDERING INFORMATION TABLE

Device code	S	E	20	N	J	H	M3
	1	2	3	4	5	6	7

- 1** - Vishay standard recovery product
- 2** - Oxide planar chip technology
- 3** - Current rating (20 = 2A)
- 4** - Package type (N = DFN package)
- 5** - Voltage rating (D = 200 V, G = 400 V, J = 600 V)
- 6** - Quality grade (H = AEC-Q101 qualified, otherwise = industry grade)
- 7** - Material / Environment category (M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free)

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE20NJ-M3/H	0.023	H	3500	7" diameter plastic tape and reel
SE20NJ-M3/I	0.023	I	14 000	13" diameter plastic tape and reel
SE20NJHM3/H ⁽¹⁾	0.023	H	3500	7" diameter plastic tape and reel
SE20NJHM3/I ⁽¹⁾	0.023	I	14 000	13" diameter plastic tape and reel

Note
⁽¹⁾ AEC-Q101 qualified

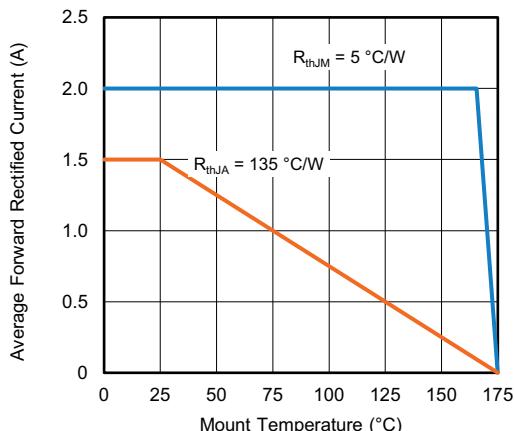
RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

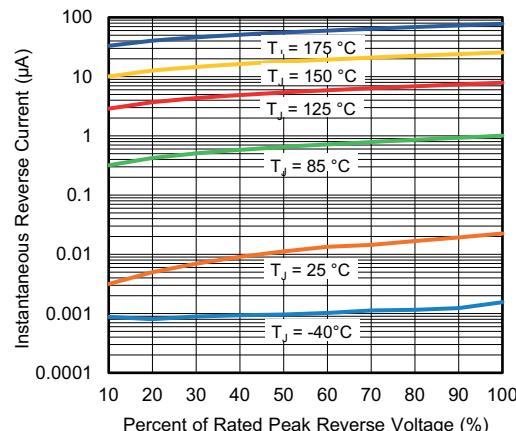


Fig. 4 - Typical Reverse Leakage Characteristics

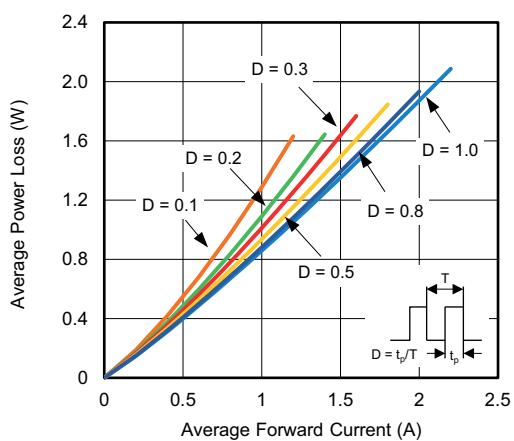


Fig. 2 - Forward Power Loss Characteristics

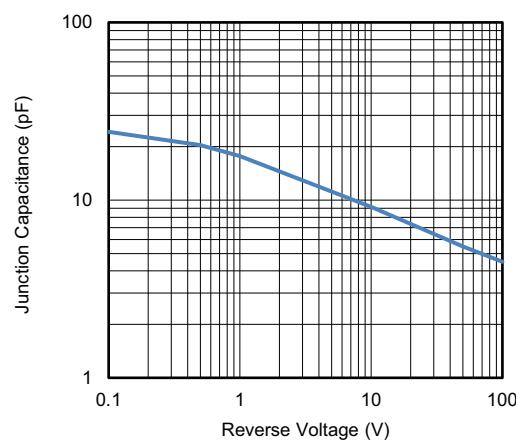


Fig. 5 - Typical Junction Capacitance

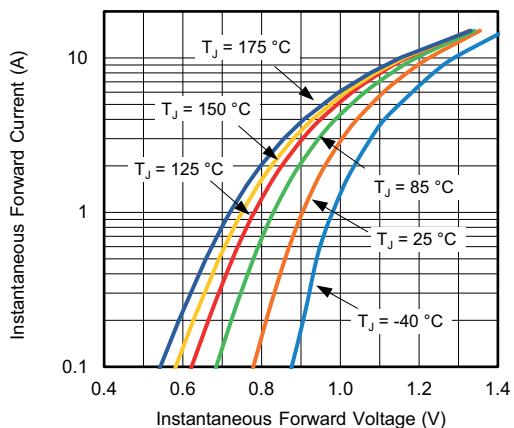


Fig. 3 - Typical Instantaneous Forward Characteristics

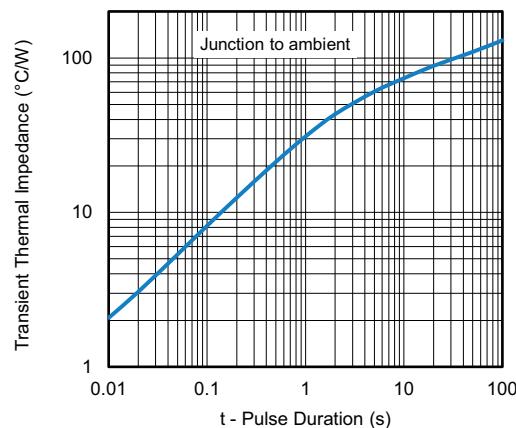
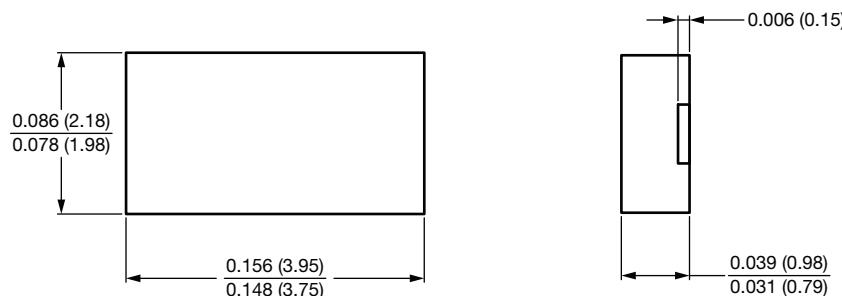
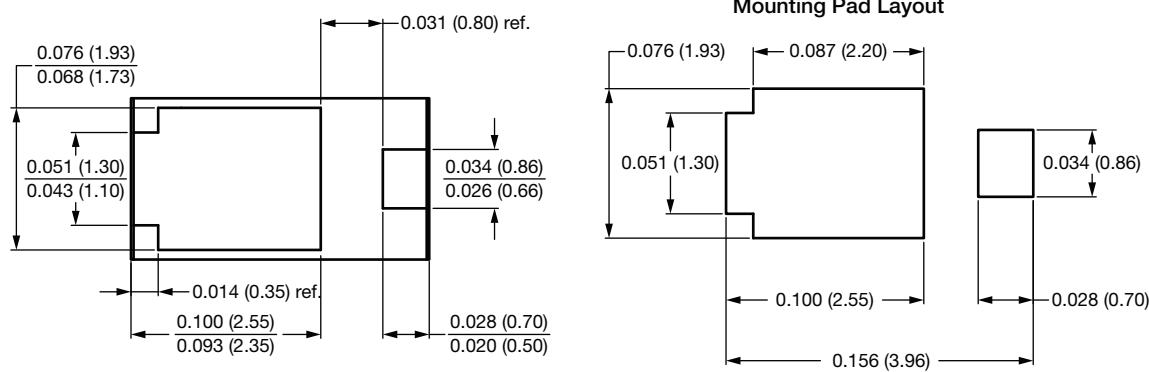


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DFN3820A

Mounting Pad Layout


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